Surface Passivation of Germanium Nanowires

Hemant Adhikari¹, Shiyu Sun², Piero Pianetta², Christopher E.D. Chidsey³, Paul C

McIntyre¹

¹Department of Materials Science and Engineering, Stanford University, ²Stanford

Synchrotron Radiation Laboratory, Stanford University, ³Department of Chemistry,

Stanford University

ABSTRACT

The surface of single crystal, cold-wall CVD-grown germanium nanowires was studied by synchrotron radiation photoemission spectroscopy (SR-PES) and also by conventional XPS. The as-grown germanium nanowires seem to be hydrogen terminated. Exposure to laboratory atmosphere leads to germanium oxide growth with oxidation states of Ge¹⁺, Ge²⁺, Ge³⁺, while exposure to UV light leads to a predominance of the Ge⁴⁺ oxidation state. Most of the surface oxide could be removed readily by aqueous HF treatment which putatively leaves the nanowire surface hydrogen terminated with limited stability in air. Alternatively, chlorine termination could be achieved by aq. HCl treatment of the native oxide-coated nanowires. Chlorine termination was found to be relatively more stable than the HF-last hydrogen termination.

One-dimensional structures such as nanotubes and nanowires are being actively investigated for various applications in nanotechnology, including nanoelectronics. Silicon and Germanium based semiconductor nanowires are among the more promising of these nanostructures for electronic and other applications because of their compatibility with existing Si CMOS integrated circuit technology. Though, historically, Si replaced Ge in microelectronics largely because of the superior structural and electrical characteristics of the Si/SiO₂ interface, recent work on surface passivation of bulk Ge crystals and gate dielectric deposition on those surfaces suggests that Ge may again become an important material for high performance transistors ^{1, 2}. In the emerging technology of 3 dimensional (3-D) nanoelectronics, germanium nanowire (GeNW) transistors are very promising components for active device layers above a single crystal silicon substrate because of a) the relatively low growth temperature, well below 400° C, of these nanowires by catalyzed chemical vapor deposition³ and b) the high intrinsic hole and electron mobilities of Ge compared to Si⁴. The potential of the GeNWs as building blocks for molecular-scale 3-D integrated circuits has been demonstrated by successful fabrication of field-effect transistors (FETs) based on p-type GeNWs with high dielectric constant (high-k) films as gate insulator⁵.

Passivation of the surface of GeNWs before deposition of the dielectric layer is one of the key steps to fabricate a working device. Detailed investigation of the surface chemistry of as-grown and air-exposed GeNWs and exploration of various chemical passivation pathways is valuable for understanding and controlling the behavior of devices made from these GeNWs.

The GeNWs used in this study were grown using colloidal gold particles (Sigma Aldrich Co.) as the catalyst. Silicon (111) substrates with native oxide were cleaned in Piranha (4 volumes H₂SO₄: 1 volume 30% by mass aqueous H₂O₂, heated to 120 0 C) and SC2 (5 volumes H₂O:1 volume 37% by mass aqueous HCl: 1 volume 30% by mass aqueous H_2O_2 , heated to 75 ^{0}C) solutions with thorough water rinses in between. (Aminopropyl)triethoxysilane, APTES, solution was spin coated on these substrates. The APTES monolayer renders the substrates positively charged and allows for the deposition of gold colloids (negatively charged) more efficiently. Subsequently these substrates were dipped in gold colloid solution (nominal particle diameter = 10nm) for 30 min. Nanowire growth was carried out in a cold wall, lamp heated, chemical vapor deposition chamber at 325 ^oC, with a GeH₄ precursor flow of 5 sccm, H₂ flow of 550 sccm and a total pressure of 30 torr (P_{GeH4}=0.273 torr). High resolution TEM reveals that these nanowires are single crystalline with (111) as the predominant growth direction. Photoelectron spectra of these nanowires were carried out using conventional XPS with an Al k_{α} source (photon energy 1486.6 eV) and also using a lower energy synchrotron source (photon energy of 80 eV for Ge 3d spectra and 800 eV for survey scans) at the Stanford Synchrotron Radiation Laboratory (SSRL). As the latter methodology gives greater surface sensitivity and allows higher energy resolution, only these results are reported in this letter. Samples described as 'as-grown' were immediately transferred to the photoelectron spectrometer in an argon gas environment. When exposed to ambient atmosphere, samples were shielded with an aluminum foil to avoid, as much as possible, exposure to UV light from fluorescent lamps in the room.

The as-grown germanium nanowires from our reactor do not show any oxide shifted Ge peaks in XPS (Fig1a). A representative spectrum obtained from a nanowire sample immediately after growth can be fitted extremely well with a Ge3d doublet. (Fig 2a)^{6,7,8}. The survey scans performed at 800 eV do not show any evidence of oxygen features (Fig 1b). These data allow us to calculate an upper bound on the average oxygen coverage of these nanowires, which is less than 0.01 monolayers². This suggests that these germanium nanowires are passivated by hydrogen during their growth and this putative hydrogen termination on as-grown wires is stable in argon atmosphere for at least 30 mins. Of the reported XPS studies in literature^{10,11} this is the first report, to our knowledge, to demonstrate oxide free surfaces suggesting completely hydrogen termination of germanium nanowires.

Compared to the well-studied Si/SiO_x system, little is known about the mechanism of oxidation of Ge and the formation of the Ge/GeO_x interface on either flat, monolithic surfaces or on nanowires. When exposed to laboratory atmosphere (covered with aluminum foil), the Ge nanowires begin the progressive growth of germanium oxide which can be seen, for example, in the spectrum obtained after varying air exposure times (Fig 1a, 1b). Growth of this surface oxide during short exposures, calculated to be 0.4 and 1.0 monolayer⁹ after 18 min and 33 min of exposure to air, respectively, could not be detected easily using a conventional laboratory XPS system. Different oxides of germanium have been reported to have different properties. For example, GeO desorbs on annealing to 400 0 C or higher, whereas GeO₂ has a lower vapor pressure but is water soluble¹². Hence it is of interest to note the oxidation states of germanium. The Ge 3d peaks obtained from nanowires which had been exposed to laboratory atmosphere for all

exposure times investigated, could be fit as a combination of a bulk Ge^{0+} substrate feature and three oxide peaks associated with the Ge^{1+} , Ge^{2+} , Ge^{3+} oxidation states with chemical shifts of 0.8eV, 1.8eV and 2.7eV respectively (Fig 2b). The binding energies of these oxide spectral components are consistent with the literature reports¹³. We did not find the presence of the Ge⁴⁺ oxidation state in our nanowires even after long exposures to air at room temperature (e.g. 13 hours in air). While we had taken care to cover these samples with Al foil to avoid exposure to UV lights (from the atmosphere or from the fluorescent lights in the laboratory), we sought to investigate the effect of controlled UV exposure on nanowire surface passivation. We found that exposing the nanowires to UV lamps for 10 minutes leads to the growth of oxide which had the predominant oxidation state of Ge⁴⁺ (Fig 2c). Further studies are in progress to understand the formation and stability of different oxides on exposure to different oxidants including H₂O₂, O₂, O atoms, and O₃ .Controlled oxidation of nanowires may provide a feasible means of passivating the surface during the fabrication process prior to gate dielectric deposition.

Silicon surfaces, etched in aqueous HF have been demonstrated to be extremely clean and are largely hydrogen terminated, leading to remarkably low electronic carrier surface recombination rates¹⁴. Hydrogen termination of flat Ge (100) after wet chemical treatments was reported only recently. On the basis of thermodynamic considerations, exposure of a Ge surface to aqueous HF should result in F termination, since the Ge-F bond (485 kJ/mol bond enthalpy) is stronger than Ge-H bond (321 kJ/mol). However it has been demonstrated that kinetic factors dominate the formation of surface species in the case of bulk (100)Ge substrates¹⁵, as had been previously established for Si. We have found similar results in the case of Germanium nanowires. As mentioned earlier, when

exposed to laboratory atmosphere these nanowires grow oxides containing Ge atoms with a range of oxidation states. Most of this native Ge oxide is removed, with the exception of very small residual Ge¹⁺ component (Fig 2d), and putative hydrogen termination is achieved, by immersing the air-exposed nanowires in 2% aq. HF for 5_min (Fig 3a). Similarly, the UV-exposed GeNWs with a predominantly Ge⁴⁺ oxidation state can be hydrogen-terminated by the 2% aqueous HF treatment. Comparing the germanium oxide peaks after exposure to air in Fig 1a and Fig 3a, we can see that the stability of the putative hydrogen termination surface obtained by aq. HF treatment (oxide coverage of 1.6 ML after 18 min in air) is inferior to the one achieved during nanowire growth (oxide coverage of 0.37 ML after 18 min in air).

The search for an air-stable surface treatment for GeNWs led us to explore the treatment with aqueous HCl. Nanowires exposed to laboratory atmosphere for 13 h were dipped in 10% aqueous HCl for 5 min. This treatment completely removed the oxide shifted germanium features. The narrow scan done at binding energies near 200eV shows Cl $2p_{3/2}$ and Cl $2p_{1/2}$ peaks at the binding energies of 200 eV and 202 eV respectively, suggesting that after aqueous HCl treatment the GeNWs are chlorine terminated, instead of the hydride termination obtained after aqueous HF treatment. These germanium peaks can be fitted to a bulk doublet (Ge⁰⁺), along with a germanium monochloride (Ge¹⁺) feature and a germanium dichloride (Ge²⁺) feature shifted from their bulk binding energies by 0.6 eV and 1.2 eV, respectively. Although, to our knowledge, the high resolution Ge3d spectrum of Cl-terminated Ge has not been reported in literature for either flat monolithic surfaces or for nanowires, our results are consistent with the Ge2p spectrum obtained from Cl-terminated Ge(111) by Lu¹⁶. A smaller chemical shift in

binding energy of the Ge3d feature for Cl termination (0.6eV), as compared to oxygen (0.8eV), is consistent with the higher electro-negativity of oxygen (3.44 on the Pauling scale) as compared to Cl (3.16). The chlorine termination obtained by aqueous HCl treatment is more resistant to oxidation than either the passivation of the as-grown GeNW sample or the passivation obtained by aqueous HF treatment. Even after 77 minutes of exposure to laboratory atmosphere, the oxide coverage for nanowires after aqueous HCl treatment is calculated to be less than 0.15 ML as compared to untreated GeNWs and HF-treated GeNWs that gave estimated oxide coverages of 1.5 ML and 1.8 ML respectively, after 77 min exposure to air. The observed robustness of the chlorine-termination can be ascribed to the strength of Ge-Cl bond (431 kJ/mol), which is larger than that of Ge-H bond (322 kJ/mol). The reason that HCl treatment yields Ge-Cl bonds while HF treatment yields putative Ge-H bonds remains unclear. It is worth noting that HCl treatment does not dissolve oxidized silicon so no direct comparison with silicon is possible.

To summarize, we have studied various chemical passivation routes for cold-wall CVD-grown single crystal germanium nanowires. We have demonstrated that as-grown nanowires are free of oxygen and appear to be completely hydrogen terminated. We have also shown that the chemical states present in surface oxides grown on the_GeNWs are dependent on the oxidizing species. Putative hydrogen termination of GeNWs can be achieved by aqueous HF treatment whereas Cl-termination can be achieved by aqueous

HCl treatment. Chorine termination presents the best passivation we have found for subsequent exposure to room temperature oxidative environments.

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FIGURES



Fig 1. High Resolution Ge 3d (1(a)) and survey scan (1(b)) XPS of as-grown Ge nanowires and the growth of oxide with time.



Fig 2. High Resolution XPS of Ge 3d peaks to resolve the presence of various oxidation states.



Fig 3.High Resolution Ge 3d XPS of HF-treated GeNWs and the growth of oxide with time. Inset shows the absence of any peak in the range of K.E.s expected for F.



Fig 4a.High Resolution Ge 3d XPS of aq.HCl treated Ge nanowires and the growth of oxide with time. Fig 4b. Ge 3d peak fitting for Cl-terminated GeNWs immediately after HCl treatment. Inset shows the presence of Cl 2p peaks.